

## Si/SiC Hybrid Module – EliteSiC™, 3-channel Boost, Q1 Package

## NXH240B120H3Q1P1G, NXH240B120H3Q1S1G

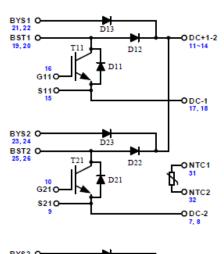
The NXH240B120H3Q1 is a case power module containing a three channel BOOST stage. The integrated field stop trench IGBTs and SiC Diodes provide lower conduction losses and switching losses, enabling designers to achieve high efficiency and superior reliability.

#### **Features**

- 1200 V Ultra Field Stop IGBTs
- Low Reverse Recovery and Fast Switching SiC Diodes
- Low Inductive Layout
- Press-fit Pins / Solder Pins
- Thermistor

### **Typical Applications**

- Solar Inverters
- ESS



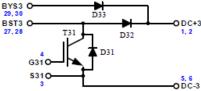
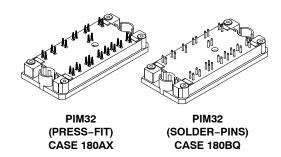
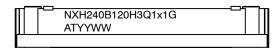


Figure 1. NXH240B120H3Q1 Schematic Diagram

1



### **MARKING DIAGRAM**



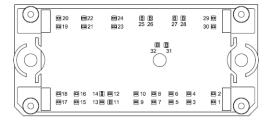
NXH240B120H3Q1x1G = Specific Device Code x = P or S

G = Pb-Free Package

AT = Assembly & Test Site Code

YYWW = Year and Work Week Code

#### **PIN CONNECTIONS**



### **ORDERING INFORMATION**

See detailed ordering and shipping information in the package dimensions section on page 4 of this data sheet.

Table 1. MAXIMUM RATINGS (Note 1)

Rating	Symbol	Value	Unit
GBT (T11, T21, T31)			
Collector-Emitter Voltage	V <sub>CES</sub>	1200	V
Gate-Emitter Voltage	V <sub>GE</sub>	±20	V
Continuous Collector Current @ T <sub>C</sub> = 80°C (T <sub>J</sub> = 150°C)	Ic	92	А
Pulsed Collector Current (T <sub>J</sub> = 150°C)	I <sub>Cpulse</sub>	276	А
Maximum Power Dissipation (T <sub>J</sub> = 150°C)	P <sub>tot</sub>	266	W
Minimum Operating Junction Temperature	T <sub>JMIN</sub>	-40	°C
Maximum Operating Junction Temperature	T <sub>JMAX</sub>	150	°C
PROTECTION DIODE (D11, D21, D31)	· · · · · ·		
Peak Repetitive Reverse Voltage	$V_{RRM}$	1200	V
Continuous Forward Current @ T <sub>C</sub> = 80°C (T <sub>J</sub> = 150°C)	I <sub>F</sub>	41	А
Repetitive Peak Forward Current (T <sub>J</sub> = 150°C)	I <sub>FRM</sub>	123	А
Maximum Power Dissipation (T <sub>J</sub> = 150°C)	P <sub>tot</sub>	54	W
Minimum Operating Junction Temperature	T <sub>JMIN</sub>	-40	°C
Maximum Operating Junction Temperature	T <sub>JMAX</sub>	150	°C
SILICON CARBIDE BOOST DIODE (D12, D22, D32)			•
Peak Repetitive Reverse Voltage	$V_{RRM}$	1200	V
Continuous Forward Current @ T <sub>C</sub> = 80°C (T <sub>J</sub> = 175°C)	I <sub>F</sub>	37	А
Repetitive Peak Forward Current (T <sub>J</sub> = 175°C)	I <sub>FRM</sub>	111	А
Maximum Power Dissipation (T <sub>J</sub> = 175°C)	P <sub>tot</sub>	99	W
Minimum Operating Junction Temperature	T <sub>JMIN</sub>	-40	°C
Maximum Operating Junction Temperature	T <sub>JMAX</sub>	175	°C
BYPASS DIODE (D13, D23, D33)	· · · · · ·		
Peak Repetitive Reverse Voltage	$V_{RRM}$	1200	V
Continuous Forward Current @ T <sub>C</sub> = 80°C (T <sub>J</sub> = 150°C)	I <sub>F</sub>	54	А
Repetitive Peak Forward Current (T <sub>J</sub> = 150°C)	I <sub>FRM</sub>	162	А
Maximum Power Dissipation (T <sub>J</sub> = 150°C)	P <sub>tot</sub>	64	W
Minimum Operating Junction Temperature	T <sub>JMIN</sub>	-40	°C
Maximum Operating Junction Temperature	T <sub>JMAX</sub>	150	°C
HERMAL PROPERTIES			•
Storage Temperature range	T <sub>stg</sub>	-40 to 150	°C
NSULATION PROPERTIES	•		•
Isolation test voltage, t = 1 sec, 60 Hz	V <sub>is</sub>	3000	$V_{RMS}$

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality

### **Table 2. RECOMMENDED OPERATING RANGES**

Rating	Symbol	Min	Max	Unit
Module Operating Junction Temperature	TJ	-40	150	°C

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

should not be assumed, damage may occur and reliability may be affected.

1. Refer to ELECTRICAL CHARACTERISTICS, RECOMMENDED OPERATING RANGES and/or APPLICATION INFORMATION for Safe Operating parameters.

Table 3. ELECTRICAL CHARACTERISTICS ( $T_J = 25^{\circ}C$  unless otherwise noted)

Parameter	Test Conditions	Symbol	Min	Тур	Max	Unit
IGBT (T11, T21, T31)						
Collector-Emitter Cutoff Current	V <sub>GE</sub> = 0 V, V <sub>CE</sub> = 1200 V	I <sub>CES</sub>	-	-	150	μΑ
Collector-Emitter Saturation Voltage	V <sub>GE</sub> = 15 V, I <sub>C</sub> = 80 A, T <sub>J</sub> = 25°C	V <sub>CE(sat)</sub>	=	2	2.7	V
	V <sub>GE</sub> = 15 V, I <sub>C</sub> = 80 A, T <sub>J</sub> = 150°C		-	2.05	=	]
Gate-Emitter Threshold Voltage	$V_{GE} = V_{CE}$ , $I_C = 80 \mu A$	V <sub>GE(TH)</sub>	4.2	5.2	6	V
Gate Leakage Current	V <sub>GE</sub> = 20 V, V <sub>CE</sub> = 0 V	I <sub>GES</sub>	=	-	450	nA
Turn-on Delay Time	T <sub>J</sub> = 25°C	t <sub>d(on)</sub>	=	100.51	=	ns
Rise Time	$V_{CE}$ = 800 V, $I_{C}$ = 50 A $V_{GE}$ = +15 V, -9 V, $R_{G}$ = 6 $\Omega$	t <sub>r</sub>	=	31.95	=	
Turn-off Delay Time	VGE = +13 V, -9 V, NG = 0 52	t <sub>d(off)</sub>	-	377.15	=	]
Fall Time		t <sub>f</sub>	-	38.27	-	1
Turn-on Switching Loss per Pulse		E <sub>on</sub>	-	1660	-	μЈ
Turn off Switching Loss per Pulse		E <sub>off</sub>	-	2470	-	1
Turn-on Delay Time	T <sub>J</sub> = 125°C	t <sub>d(on)</sub>	-	89.65	-	ns
Rise Time	$V_{CE} = 800 \text{ V, } I_{C} = 50 \text{ A}$ $V_{GE} = +15 \text{ V, } -9 \text{ V, } R_{G} = 6 \Omega$	t <sub>r</sub>	-	32	-	1
Turn-off Delay Time	V <sub>GE</sub> = +15 V, -9 V, n <sub>G</sub> = 0 \( \omega \)	t <sub>d(off)</sub>	_	440.78	_	1
Fall Time		t <sub>f</sub>	_	169.39	_	1
Turn-on Switching Loss per Pulse		E <sub>on</sub>	_	1660	_	μJ
Turn off Switching Loss per Pulse		E <sub>off</sub>	=	5220	=	1
Input Capacitance	V <sub>CE</sub> = 20 V, V <sub>GE</sub> = 0 V, f = 10 kHz	C <sub>ies</sub>	-	19082	-	pF
Output Capacitance		C <sub>oes</sub>	=	541	=	1
Reverse Transfer Capacitance		C <sub>res</sub>	=	387	=	1
Total Gate Charge	$V_{CE}$ = 600 V, $I_{C}$ = 25 A, $V_{GE}$ = ±15 V	Qg	-	1320	=	nC
Thermal Resistance - chip-to-heatsink	Thermal grease,	R <sub>thJH</sub>	=	0.464	=	°C/W
Thermal Resistance - chip-to-case	Thickness = 2 Mil $\pm 2\%$ , $\lambda$ = 2.87 W/mK	R <sub>thJC</sub>	-	0.263	=	°C/W
PROTECTION DIODE (D11, D21, D31)						
Diode Forward Voltage	I <sub>F</sub> = 30 A, T <sub>J</sub> = 25°C	V <sub>F</sub>	0.8	1.0	1.3	V
	I <sub>F</sub> = 30 A, T <sub>J</sub> = 150°C		-	0.98	=	1
Thermal Resistance - chip-to-heatsink	Thermal grease,	R <sub>thJH</sub>	-	1.303	=	°C/W
Thermal Resistance - chip-to-case	Thickness = 2 Mil $\pm 2\%$ , $\lambda = 2.87$ W/mK	R <sub>thJC</sub>	-	0.968	=	°C/W
SILICON CARBIDE BOOST DIODE (D12,	D22, D32)					
Diode Forward Voltage	I <sub>F</sub> = 30 A, T <sub>J</sub> = 25°C	V <sub>F</sub>	-	1.46	1.7	V
	I <sub>F</sub> = 30 A, T <sub>J</sub> = 175°C		=	2.12	=	1
Reverse Recovery Time	T <sub>J</sub> = 25°C	t <sub>rr</sub>	-	21.5	=	ns
Reverse Recovery Charge	$V_{CE} = 800 \text{ V, } I_{C} = 50 \text{ A}$	Q <sub>rr</sub>	-	87.82	=	μС
Peak Reverse Recovery Current	$V_{GE} = +15 \text{ V}, -9 \text{ V}, R_{G} = 6 \Omega$	I <sub>RRM</sub>	-	7.21	-	Α
Peak Rate of Fall of Recovery Current		di/dt	=	1282.75	=	A/μs
Reverse Recovery Energy		E <sub>rr</sub>	=	23.61	=	μJ
Reverse Recovery Time	T <sub>J</sub> = 125°C	t <sub>rr</sub>	=	25.73	=	ns
Reverse Recovery Charge	$V_{CE} = 800 \text{ V}, I_{C} = 50 \text{ A}$	Q <sub>rr</sub>	_	108.23	-	μС
Peak Reverse Recovery Current	$V_{GE}$ = +15 V, -9 V, $R_{G}$ = 6 $\Omega$	I <sub>RRM</sub>	_	7.6	_	A
Peak Rate of Fall of Recovery Current	1	di/dt	_	1275.94	_	A/μs
Reverse Recovery Energy	1	E <sub>rr</sub>		30.68	_	μJ

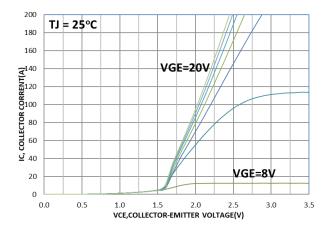
Table 3. ELECTRICAL CHARACTERISTICS (T<sub>.I</sub> = 25°C unless otherwise noted)

Parameter	Test Conditions	Symbol	Min	Тур	Max	Unit
SILICON CARBIDE BOOST DIODE (D12,	D22, D32)					•
Thermal Resistance - chip-to-heatsink	Thermal grease,	$R_{thJH}$	-	0.958	-	°C/W
Thermal Resistance - chip-to-case	Thickness = 2 Mil $\pm 2\%$ , $\lambda = 2.87$ W/mK	R <sub>thJC</sub>	-	0.682	-	°C/W
BYPASS DIODE (D13, D23, D33)						
Diode Forward Voltage	I <sub>F</sub> = 50 A, T <sub>J</sub> = 25°C	$V_{F}$	-	1.1	1.3	V
	I <sub>F</sub> = 50 A, T <sub>J</sub> = 150°C		-	0.95	_	1
Thermal Resistance - chip-to-heatsink			-	1.095	-	°C/W
Thermal Resistance - chip-to-case	Thickness = 2 Mil $\pm 2\%$ , $\lambda = 2.87$ W/mK	R <sub>thJC</sub>	-	0.767	-	°C/W
THERMISTOR CHARACTERISTICS						
Nominal resistance	T = 25°C	R <sub>25</sub>	-	5	-	kΩ
Nominal resistance	T = 100°C	R <sub>100</sub>	-	490.6	_	Ω
Deviation of R25		ΔR/R	-1	=	1	%
Power dissipation		$P_{D}$	-	5	_	mW
Power dissipation constant			-	1.3	-	mW/K
B-value	B(25/85), tolerance ±1%		=	3435	_	K

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

### **ORDERING INFORMATION**

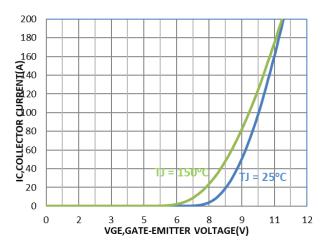
Orderable Part Number	Marking	Package	Shipping
NXH240B120H3Q1P1G	NXH240B120H3Q1P1G	Q1 BOOST, Case 180AX Press-fit Pins (Pb-Free)	21 Units / Blister Tray
NXH240B120H3Q1S1G	NXH240B120H3Q1S1G	Q1 BOOST, Case 180BQ Solder Pins (Pb-Free)	21 Units / Blister Tray



TJ =150°C 180 160 COLLECTOR CORRENT(A) 100 100 100 100 100 VGE=20V VGE=8V 40 کے 20 0 0.0 0.5 1.5 2.0 3.0 3.5 2.5 VCE,COLLECTOR-EMITTER VOLTAGE(V)

Figure 2. Typical Output Characteristics

Figure 3. Typical Output Characteristics



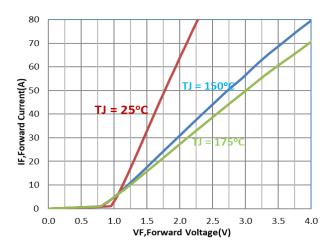
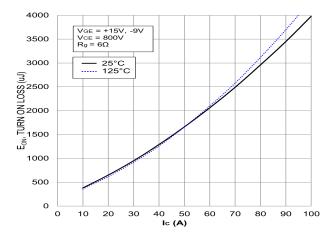


Figure 4. Typical Transfer Characteristics

Figure 5. Diode Forward Characteristics



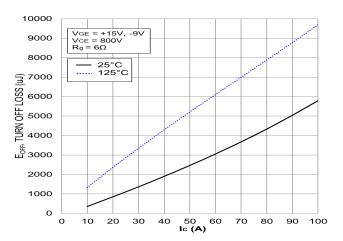


Figure 6. Typical Turn ON Loss vs. I<sub>C</sub>

Figure 7. Typical Turn OFF Loss vs. I<sub>C</sub>

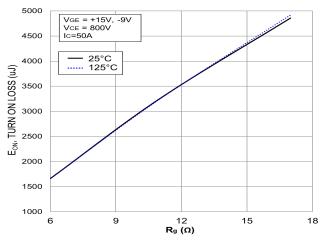


Figure 8. Typical Turn ON Loss vs. R<sub>G</sub>

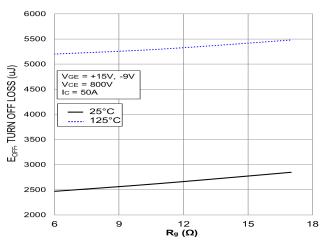


Figure 9. Typical Turn OFF Loss vs. R<sub>G</sub>

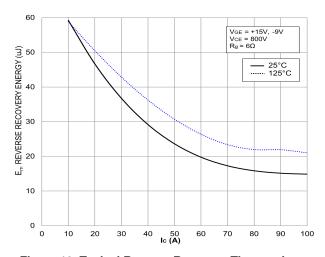


Figure 10. Typical Reverse Recovery Time vs. I<sub>C</sub>

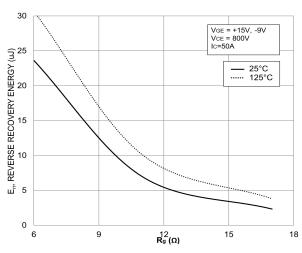


Figure 11. Typical Reverse Recovery Time vs. R<sub>G</sub>

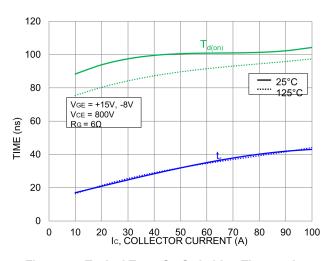


Figure 12. Typical Turn-On Switching Time vs. I<sub>C</sub>

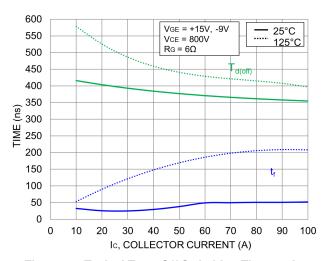


Figure 13. Typical Turn-Off Switching Time vs. I<sub>C</sub>

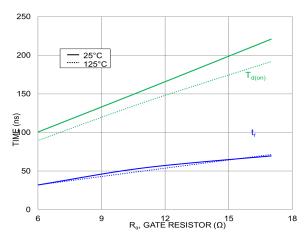


Figure 14. Typical Turn-On Switching Time vs. R<sub>G</sub>

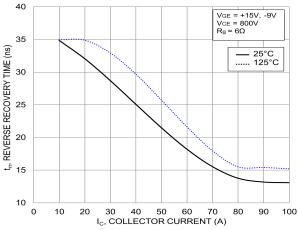


Figure 16. Typical Reverse Recovery Time vs. I<sub>C</sub>

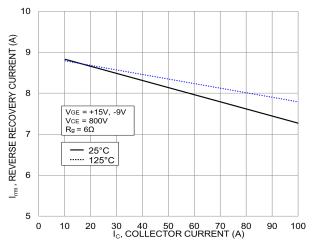


Figure 18. Typical Reverse Recovery Peak Current vs. I<sub>C</sub>

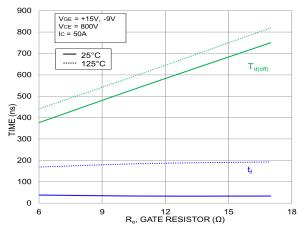


Figure 15. Typical Turn-Off Switching Time vs. R<sub>G</sub>

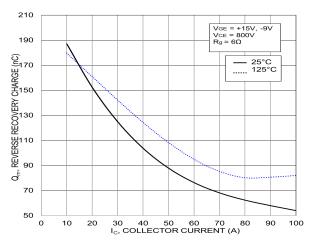


Figure 17. Typical Reverse Recovery Charge vs. I<sub>C</sub>

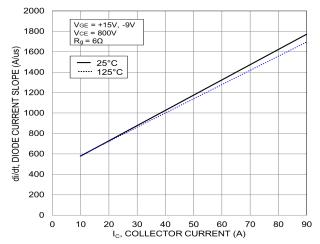


Figure 19. Typical di/dt vs. I<sub>C</sub>

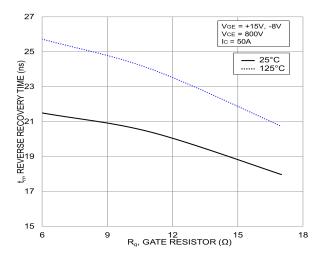


Figure 20. Typical Reverse Recovery Time vs.  $R_{\mbox{\scriptsize G}}$ 

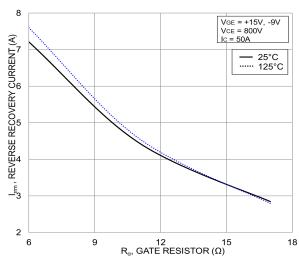


Figure 22. Typical Reverse Recovery Current vs. R<sub>G</sub>

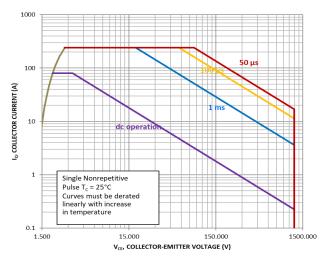


Figure 24. FBSOA

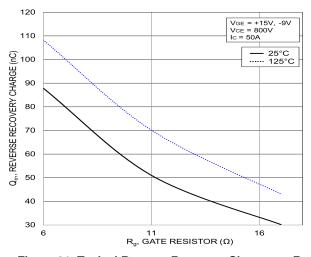


Figure 21. Typical Reverse Recovery Charge vs. R<sub>G</sub>

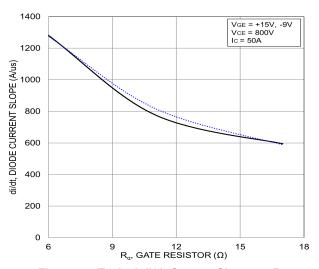


Figure 23. Typical di/dt Current Slope vs. R<sub>G</sub>

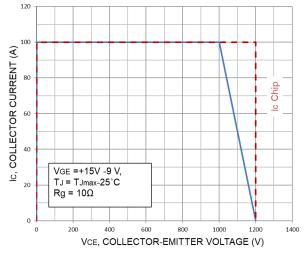


Figure 25. RBSOA

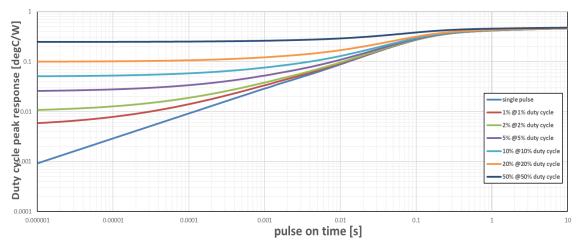


Figure 26. Transient Thermal Impedance (T1, T2, T3)

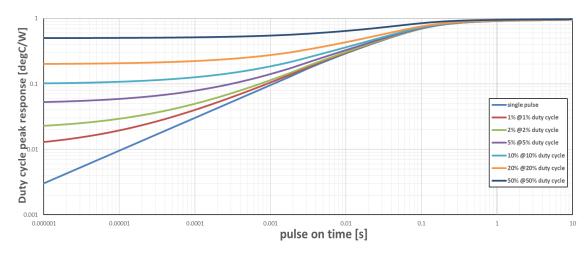


Figure 27. Transient Thermal Impedance (D12, D22, D32)

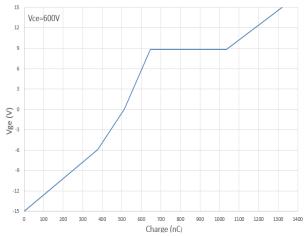


Figure 28. Gate Voltage vs. Gate Charge

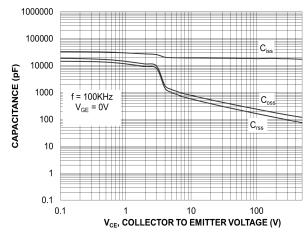


Figure 29. Gate Voltage vs. Gate Charge

## TYPICAL CHARACTERISTICS - DIODE (D13, D23, D33)

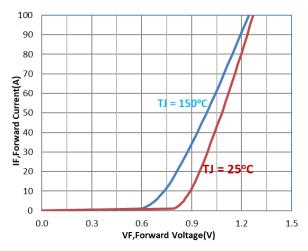


Figure 30. Diode Forward Characteristics

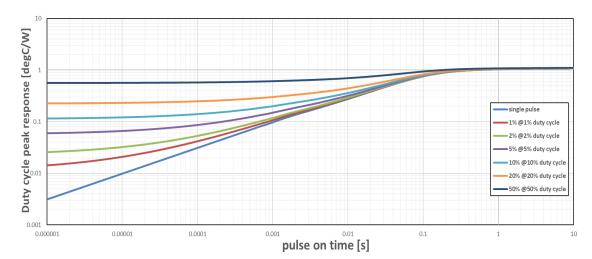


Figure 31. Transient Thermal Impedance

## TYPICAL CHARACTERISTICS - DIODE (D11, D21, D31)

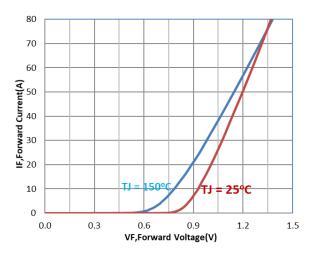


Figure 32. Diode Forward Characteristics

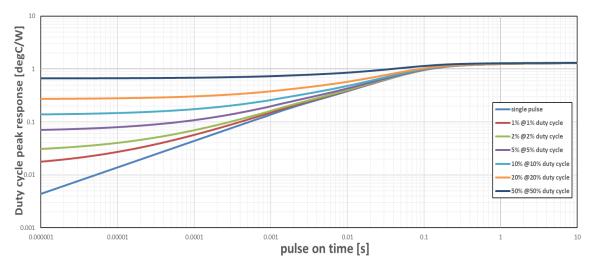
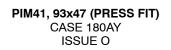


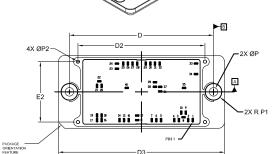
Figure 33. Transient Thermal Impedance

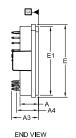
EliteSiC is a trademark of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries.





**DATE 19 MAR 2019** 





	MILLIMETERS				
DIM	MIN.	NOM.	MAX.		
Α	11.60	12.00	12.40		
A1	4.40	4.70	5.00		
A2	16.30	16.70	17.10		
A3	16,90	17,30	17.70		
A4	13.97	14.18	14.39		
b	1.61	1.66	1.71		
b1	0.75	0.80	0.85		
D	92.90	93.00	93.10		
D1	104.45	104.75	105.05		
D2	81,80	82.00	82.20		
D3	106.90	107.20	107.50		
Е	46.70	47.00	47.30		
E1	44.10	44.40	44.70		
E2	38.80	39.00	39.20		
Ρ	5,40	5,50	5,60		
P1	5.15	5.35	5.55		
P2	2,00	2,20	2,40		

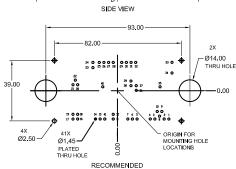
чο	Т	Е	S	٠	

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2009.
- 2. CONTROLLING DIMENSION: MILLIMETERS
- 3. DIMENSIONS 6 AND 61 APPLY TO THE PLATED TERMINALS AND ARE MEASURED AT DIMENSION A4.
- 4. POSITION OF THE CENTER OF THE TERMINALS AND MOUNTING HOLES IS DETERMINED FROM DATUM B THE CENTER OF DIMENSION D, X DIRECTION, AND FROM DATUM A, Y DIRECTION, POSITIONAL TOLERANCE AS NOTED IN DRAWING, APPLIES TO BOTH TERMINALS AND MOUNTING HOLES IN BOTH DIRECTIONS.
- PACKAGE MARKING IS LOCATED AS SHOWN ON THE SIDE OPPOSITE THE PACKAGE ORIENTATION FEATURES.
- 6 MOUNTING RECOMMENDATION IS SHOWN AS VIEWED FROM THE PCB TOP LAYER LOOKING DOWN TO SUBSEQUENT LAYERS.

	41X b		1X b1	40
		Mada taman		A2
PACKAGE MARKING  LOCATION		<b></b>	0	A1_
	•	D1——— SIDE VIEW		

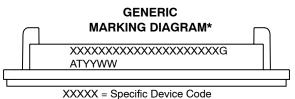
TOP VIEW

**Ф** 0.80**©** С А В



MOUNTING PATTERN

PIN		PIN POSITION			PIN POSITION	
2         30,15         -18,25         24         -15,85         18,25           3         24.15         -18,25         25         -11,75         18,25           4         21.15         -18,25         26         -8,75         18,25           5         12,65         -18,25         27         -5,75         18,25           6         9,85         -18,25         28         -2,75         18,25           8         27,15         -16,40         30         5,75         18,25           9         28,65         -13,40         31         8,75         18,25           10         25,65         -13,40         32         11,75         18,25           11         -2,75         -18,25         33         35,20         18,30           12         -2,75         -18,25         34         35,20         11,45           13         -11,20         -18,25         36         12,10         0,25           15         n/a         n/a         37         12,10         3,25           15         n/a         n/a         37         12,10         3,25           16         -25,70         -18,25 <td< td=""><td>PIN</td><td>Х</td><td>Υ</td><td>PIN</td><td>Х</td><td>Υ</td></td<>	PIN	Х	Υ	PIN	Х	Υ
3         24.15         -18.25         25         -11.75         18.25           4         21.15         -18.25         26         -8.75         18.25           5         12.85         -18.25         27         -5.75         18.25           6         9.65         -18.25         28         -2.75         18.25           7         6.85         -18.25         29         2.75         18.25           8         27.15         -18.26         30         5.75         18.25           9         28.65         -13.40         31         6.75         18.25           10         25.65         -13.40         32         11.75         18.25           11         -2.75         -18.25         34         35.20         11.45           13         -11.20         -18.25         34         35.20         11.45           14         -14.20         -18.25         36         12.10         0.25           15         n/a         n/a         37         12.10         0.25           16         -25.70         -18.25         38         8.70         3.25           17         -28.70         -15.25	1	33.15	-18.25	23	-15.85	14.90
4   21.15   -18.25   26   -8.75   18.25     5   12.65   -18.25   27   -5.75   18.25     6   9.85   -18.25   28   -2.75   18.25     7   6.85   -18.25   29   2.75   18.25     8   27.15   -16.40   30   5.75   18.25     9   28.68   -13.40   31   8.75   18.25     10   25.65   -13.40   32   11.75   18.25     11   -2.75   -18.25   33   35.20   18.30     12   -2.75   -18.25   34   35.20   11.45     13   -1120   -18.25   35   27.50   2.50     14   -14.20   -18.25   36   12.10   0.25     15   n/a	2	30.15	-18.25	24	-15.85	18.25
5         12,65         -18,25         27         -5,75         18,25           6         9,85         -18,25         28         -2,75         18,25           7         6,85         -18,25         29         2,75         18,25           8         27,15         -16,40         30         5,75         18,25           9         28,65         -13,40         31         8,75         18,25           10         25,65         -13,40         32         11,75         18,25           11         -2,75         -18,25         33         35,20         18,30           12         -2,75         -18,25         34         35,20         11,30           13         -11,20         -18,25         34         35,20         14,30           14         -14,20         -18,25         36         12,10         0,25           15         n/a         n/a         37         12,10         3,25           16         -25,70         -18,25         38         8,70         3,25           17         -28,70         -18,25         39         8,70         6,25           18         -25,70         -15,25	3	24.15	-18.25	25	-11.75	18.25
6         9.85         -18.25         28         -2.75         18.25           7         6.85         -18.25         29         2.75         18.25           8         27.15         -16.40         30         5.75         18.25           9         28.65         -13.40         31         6.75         18.25           10         25.65         -13.40         32         11.75         18.25           11         -2.75         -18.25         33         35.20         11.45           13         -11.20         -18.25         34         35.20         11.45           14         -14.20         -18.25         36         12.10         0.25           15         n/a         n/a         37         12.10         0.25           16         -25.70         -18.25         38         8.70         3.25           17         -28.70         -18.25         39         8.70         6.25           18         -25.70         -18.25         40         -0.50         2.50           19         -28.70         15.25         41         -8.20         -18.25           20         -25.70         3.85	4	21.15	-18.25	26	-8.75	18.25
7 6.655 -18.25 29 2.75 18.25 8 27.15 -16.40 30 5.75 18.25 9 2.855 -13.40 31 8.75 18.25 10 25.65 -13.40 32 11.75 18.25 11 -2.75 18.25 33 35.20 18.30 12 -2.75 18.25 34 35.20 11.45 13 -11.20 18.25 35 27.50 2.50 14 -14.20 -18.25 36 12.10 0.25 15 n/a n/a 37 12.10 3.25 15 n/a 14.25 38 8.70 3.25 17 -2.870 18.25 39 8.70 6.25 17 -2.870 18.25 39 8.70 6.25 18 -2.570 15.25 40 9.50 2.50 19 -2.570 15.25 41 -2.20 -2.50 2.50 2.50 2.50 2.20 -2.50 2.50 3.85 2.50 2.50 2.50 2.50 2.50 2.50 2.50 2.5	5	12.65	-18.25	27	-5.75	18.25
8         27,15         -16,40         30         5,75         18,25           9         28,65         -13,40         31         8,76         18,25           10         26,65         -13,40         32         11,75         18,25           11         -2,75         -18,25         33         35,20         18,30           12         -2,75         -18,25         34         35,20         11,45           13         -11,20         -18,25         36         27,50         2,50           14         -14,20         -18,25         36         12,10         0,25           15         na         n/a         37         12,10         3,25           16         -25,70         -18,25         38         8,70         3,25           17         -28,70         -18,25         39         8,70         6,25           18         -25,70         -15,25         40         -9,50         2,50           19         -28,70         -15,26         41         -8,20         -18,25           20         -25,70         3,85         41         -8,20         -18,25           21         -28,70         3,85	6	9.65	-18.25	28	-2.75	18.25
9 28.65 -13.40 31 8.75 18.25 10 25.65 -13.40 32 11.75 18.25 11 2-275 18.25 33 35.20 11.45 13 -11.20 18.25 35 27.50 2.50 14 4 -14.20 18.25 36 12.10 0.25 15 m/a n/a 37 12.10 3.25 16 -25.70 18.25 38 8.70 3.25 16 -25.70 18.25 39 8.70 3.25 16 -25.70 18.25 39 8.70 6.25 16 -25.70 18.25 39 8.70 6.25 16 -25.70 18.25 39 8.70 6.25 16 -25.70 18.25 40 -9.50 2.50 19 -28.70 15.25 41 -8.20 18.25 20 -25.70 3.85 21 -28.70 3.85 21 -28.70 3.85 21 -28.70 3.85	7	6.65	-18.25	29	2.75	18.25
10	8	27.15	-16.40	30	5.75	18,25
11         -2.75         -18.25         33         35.20         18.30           12         -2.75         -15.26         34         35.20         11.45           13         -11.20         -18.25         35         27.50         2.50           14         -14.20         -18.25         36         12.10         0.25           15         n/a         n/a         37         12.10         3.25           16         -25.70         -18.25         38         8.70         3.25           17         -28.70         -18.25         39         8.70         6.25           18         -25.70         -15.25         40         -9.50         2.50           19         -28.70         -15.25         41         -8.20         -18.25           20         -25.70         3.85	9	28.65	-13.40	31	8.75	18.25
12	10	25.65	-13.40	32	11.75	18.25
13	11	-2.75	-18.25	33	35.20	18.30
14         -14,20         -18,25         36         12,10         0,25           15         n/a         n/a         37         12,10         3,25           16         -25,70         -18,25         38         8,70         3,25           17         -28,70         -18,25         39         8,70         6,25           18         -25,70         -15,25         40         -9,50         2,50           19         -28,70         -15,25         41         -8,20         -18,25           20         -25,70         3,85	12	-2.75	-15.25	34	35.20	11.45
15	13	-11.20	-18.25	35	27.50	2.50
16         -26.70         -18.25         38         8.70         3.25           17         -28.70         -18.25         39         8.70         6.25           18         -26.70         -15.25         40         -9.50         2.50           19         -28.70         -15.25         41         -8.20         -18.25           20         -25.70         3.85         -18.25         -18.25	14	-14.20	-18.25	36	12.10	0.25
17	15	n/a	n/a	37	12.10	3.25
18         -25.70         -15.25         40         -9.50         2.50           19         -28.70         -15.25         41         -9.20         -18.25           20         -25.70         3.85	16	-25.70	-18.25	38	8.70	3.25
19 -28.70 -15.25 41 -8.20 -18.25 20 -25.70 3.85 21 -28.70 3.85	17	-28.70	-18.25	39	8.70	6.25
20 -25.70 3.85 21 -28.70 3.85	18	-25.70	-15.25	40	-9.50	2.50
21 -28.70 3.85	19	-28.70	-15.25	41	-8.20	-18.25
	20	-25.70	3.85			
22 27.20 6.96	21	-28.70	3,85			
22 -27-20 0:05	22	-27.20	6.85			



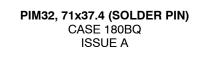
G = Pb-Free Package
AT = Assembly & Test Site Code

YYWW = Year and Work Week Code

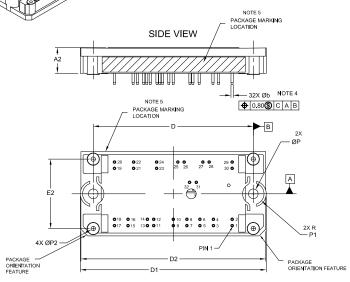
\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

DESCRIPTION:	PIM41, 93x47 (PRESS FIT)		PAGE 1 OF 1			
DOCUMENT NUMBER:	98AON03679H	Electronic versions are uncontrolled except when accessed directly from the Document Repository. Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.				

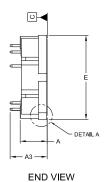
onsemi and ONSEMI are trademarks of Semiconductor Components Industries, LLC dba onsemi or its subsidiaries in the United States and/or other countries. onsemi reserves the right to make changes without further notice to any products herein. onsemi makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. onsemi does not convey any license under its patent rights nor the rights of others.



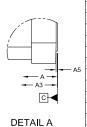
**DATE 23 JUL 2021** 



TOP VIEW



	MILLIMETERS					
DIM	MIN.	NOM.	MAX.			
Α	11.70	12.00	12.30			
A2	10.90	11.40	11.90			
А3	15.90	16.40	16.90			
A5	0.00	-	0.45			
b	0.90	1.00	1.10			
D	70.50	71.00	71.50			
D1	82.00	82.50	83.00			
D2	81.50	82.00	82.50			
E	36.90	37.40	37.90			
E2	30.30	30.80	31.30			
Р	4.30	4.40	4.50			
P1	4.55	4.75	4.95			
P2	2.00 REF					



		PIN POS	SITION	Г		PIN POS	SITION
	PIN	х	Υ		PIN	Х	Υ
	1	26.10	-14.10		17	-26.10	-14.10
	2	26.10	-11.30		18	-26.10	-11.30
	3	17.80	-14.10		19	-26.10	11.30
	4	17.80	-11.30		20	-26.10	14.10
	5	11.80	-14.10		21	-17.60	11.30
	6	11.80	-11.30		22	-17.60	14.10
5	7	6.00	-14.10		23	-7.40	11.30
	8	6.00	-11.30		24	-7.40	14.10
	9	0.00	-14.10		25	2.00	14.10
	10	0.00	-11.30		26	4.80	14.10
	11	-8.70	-14.10		27	13.10	14.10
	12	-8.70	-11.30		28	15.90	14.10
	13	-11.50	-14.10		29	26.10	14.10
	14	-11.50	-11.30		30	26.10	11.30
	15	-20.10	-14.10		31	10.20	5.10
	16	-20.10	-11.30		32	7,20	5.10

#### 2X

0.00

THRU HOLE

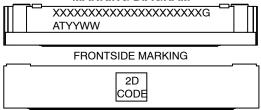
ORIGIN FOR MOUNTING HOLE LOCATIONS

RECOMMENDED MOUNTING PATTERN\*
For additional information on our Pb-Free strategy and soldering details, please download the On Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

### NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2009.
- 2. CONTROLLING DIMENSION: MILLIMETERS
- 3. DIMENSION 6 APPLIES TO THE PLATED TERMINALS AND
  IS MEASURED BETWEEN 1.00 AND 3.00 FROM THE TERMINAL TIP.
- POSITION OF THE CENTER OF THE TERMINALS AND MOUNTING HOLES IS DETERMINED FROM DATUM B THE CENTER OF DIMENSION D, X DIRECTION, AND FROM DATUM A, Y DIRECTION. POSITIONAL TOLERANCE, AS NOTED IN DRAWING, APPLIES TO BOTH TERMINALS AND MOUNTING HOLES IN BOTH DIRECTIONS.
- 5. PACKAGE MARKING IS LOCATED, AS SHOWN, ON THE SIDE OPPOSITE THE PACKAGE ORIENTATION FEATURES.
- 6. MOUNTING RECOMMENDATION IS SHOWN AS VIEWED FROM THE PCB TOP LAYER LOOKING DOWN TO SUBSEQUENT LAYERS.

## GENERIC MARKING DIAGRAM\*



### **BACKSIDE MARKING**

XXXXX = Specific Device Code

G = Pb-Free Package

AT = Assembly & Test Site Code YYWW = Year and Work Week Code \*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

DOCUMENT NUMBER:	98AON15094H	Electronic versions are uncontrolled except when accessed directly from the Document Repository. Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.	
DESCRIPTION:	PIM32, 71x37.4 (SOLDER PIN)		PAGE 1 OF 1

ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. ON Semiconductor does not convey any license under its patent rights nor the rights of others.

onsemi, Onsemi, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at <a href="www.onsemi.com/site/pdf/Patent-Marking.pdf">www.onsemi.com/site/pdf/Patent-Marking.pdf</a>. Onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using onsemi products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by onsemi. "Typical" parameters which may be provided in onsemi data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. onsemi does not convey any license under any of its intellectual property rights nor the rights of others. onsemi products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA class 3 medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase

#### ADDITIONAL INFORMATION

**TECHNICAL PUBLICATIONS:** 

 $\textbf{Technical Library:} \ \underline{www.onsemi.com/design/resources/technical-documentation}$ 

onsemi Website: www.onsemi.com

ONLINE SUPPORT: www.onsemi.com/support

For additional information, please contact your local Sales Representative at

www.onsemi.com/support/sales